



100V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	RDS(ON) Max	I _D Max T _C = +25°C	
100V	3mΩ @ V _{GS} = 10V	152A	
1000	5mΩ @ V _{GS} = 6V	118A	

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

Features

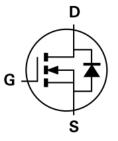
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

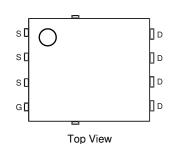
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.097 grams (Approximate)







Internal Schematic



Pin Configuration

Ordering Information (Note 4)

Dout Number	Deekene	Packing		
Part Number	Package	Qty.	Carrier	
DMT10H003SPSW-13	PowerDI5060-8 (SWP) (Type Q)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Oll = Manufacturer's Marking T10H003SW = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	100	V	
Gate-Source Voltage		Vgss	±20	V	
Continuous Drain Current, V _{GS} = 10V (Note 6)	T _C = +25°C	I _D	152	۸	
Continuous Diain Current, vgs = 10v (Note 6)	T _C = +70°C		121	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	608	Α	
Maximum Continuous Body Diode Forward Current (Note 6)		Is	152	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I _{SM}	608	Α	
Avalanche Current, L = 3mH		las	20.2	Α	
Avalanche Energy, L = 3mH		Eas	612	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P _D	2.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	57	°C/W	
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	139	W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	0.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

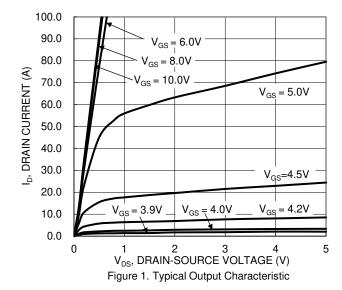
Electrical Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

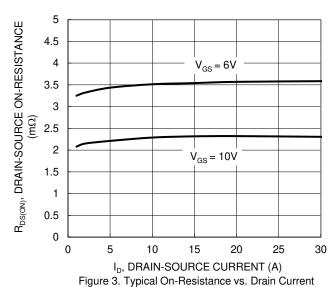
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 80V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2	2.6	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Б	_	2.2	3	mΩ	V _{GS} = 10V, I _D = 30A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	3.4	5	mΩ	V _{GS} = 6V, I _D = 25A	
Diode Forward Voltage	V _{SD}	_	8.0	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)			•				
Input Capacitance	Ciss	_	5542	_		V _{DS} = 50V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	1681	_	рF		
Reverse Transfer Capacitance	C _{rss}	_	34	_			
Gate Resistance	Rg	_	1.46	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	85.0	_		$V_{DS} = 50V$, $I_{D} = 30A$, $V_{GS} = 10V$	
Gate-Source Charge	Qgs	_	21.0	_	nC		
Gate-Drain Charge	Qgd		19.7				
Turn-On Delay Time	t _{D(ON)}	_	16.0	_		$V_{DD} = 50V, \ V_{GS} = 10V,$ $I_{D} = 30A, \ R_{g} = 3\Omega$	
Turn-On Rise Time	tr	_	23.2	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	45.3	_	115		
Turn-Off Fall Time	tF	_	29.6	_			
Body Diode Reverse Recovery Time	trr	_	71.7	_	ns	I- 004 di/dh 1004/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	163.1	_	nC	$\frac{100}{100}$ IF = 30A, di/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

- Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.







and Gate Voltage

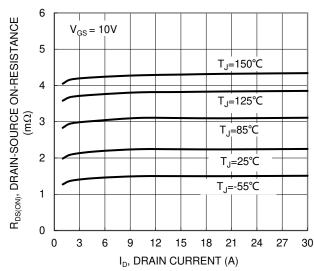


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

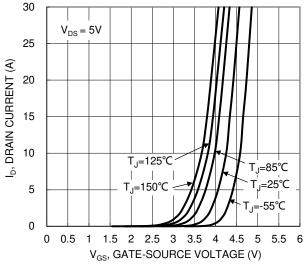


Figure 2. Typical Transfer Characteristic

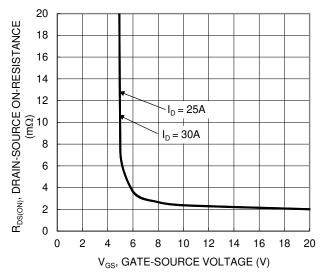


Figure 4. Typical Transfer Characteristic

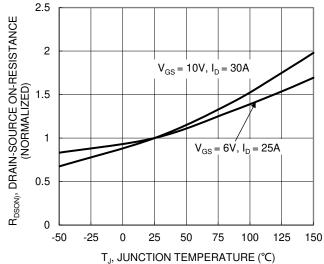
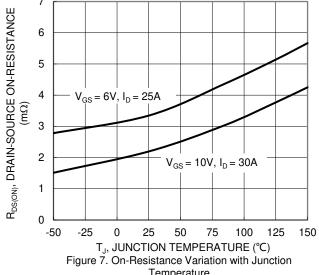
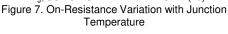


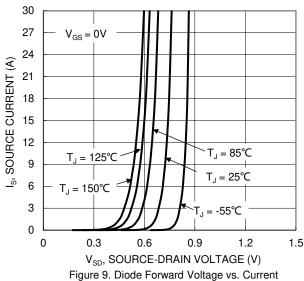
Figure 6. On-Resistance Variation with Junction Temperature

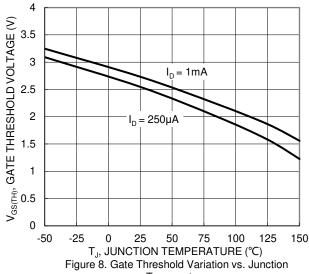












Temperature

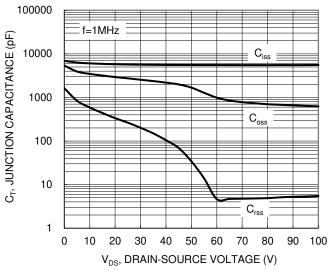


Figure 10. Typical Junction Capacitance

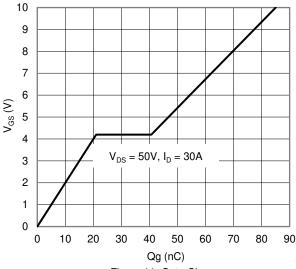


Figure 11. Gate Charge

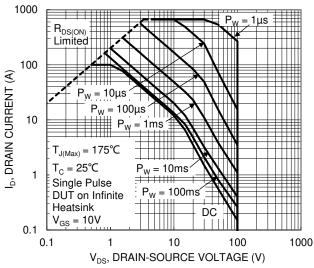


Figure 12. SOA, Safe Operation Area



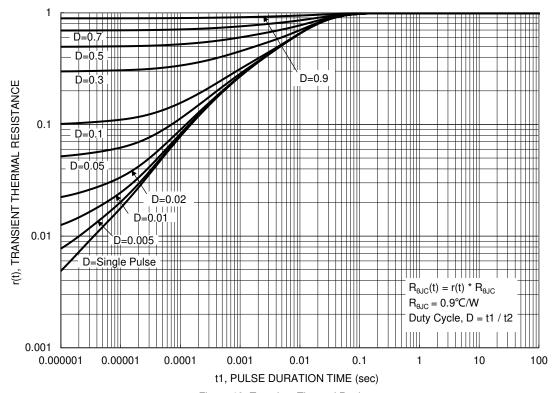


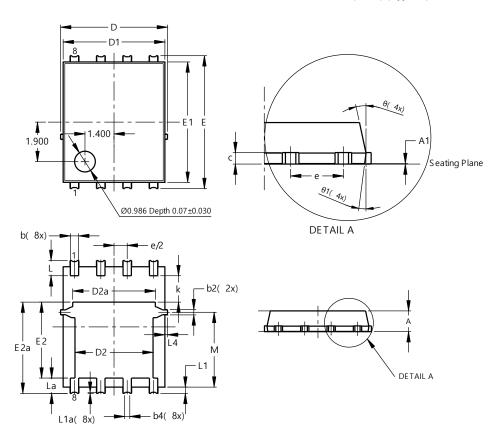
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)

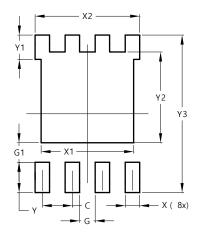


PowerDI5060-8 (SWP) (Type Q)					
Dim	Min Max		Тур		
Α	0.90	1.10	1.00		
A 1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	C).25REF			
С	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6.40 BSC				
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value (in mm)		
C	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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